RECORDA

09-06-2000

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To the Hon. Commissioner of Patents & Trademarks: Please record the attached original documents or copy thereof.

 Name of conveying party 	tv(ies):
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Yasukazu NAKATA, Akira ICHIKAWA, Katsuhisa TAGUCHI and Yuichi IWAKATA

Additional name(s) of conveying party(ies) attached? [] Yes [X] No

3. Nature of conveyance:

[X] Assignment

[] Merger

[] Change of Name [] Other

[] Security Agreement

Execution Date: July 3, 2000

2. Name and address of receiving party(ies):

Name:

LINTEC CORPORATION

Street Address: 23-23, Hon-cho, Itabashi Tokyo 173-0001, JAPAN



4. Application number(s) or patent (numbers):

If this document is being filed together with a new application, the execution date of the application is: July 3, 2000

A. Patent Application No(s).

B. Patent No(s).

5. Name and address of party to whom corre-08/29/2000 spende 068/69/10941951 02 FC:581 be mailed:

YOUNG & THOMPSON Second Floor 745 South 23rd Street Arlington, VA 22202

6. Total number of applications and patents involved:

Additional numbers attached? [] Yes [X] No

One

7. Total fee (37 CFR 3.41).....\$ 40.00 [X] Enclosed

> [] Authorized to be charged to deposit account

8. Deposit Account No. 25-0120 (Attach duplicate copy of this page if paying by deposit account.)

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Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Benoît Caste Name of Person Signing

August

Total number of pages including cover sheet: [2]

PATENT REEL: 011036 FRAME: 0158

ASSIGNMENT

	WHEREAS, _ we, Yasukazu NAKATA, Akira ICHIKAWA, Katsuhisa TAGUCHI	
	and_Yuichi_IWAKATA	
	ha_Ye invented certain new and useful improvements inCARD_AND_PROCESS_FOR_PRODUCING	
	_ THE_CARD	
	for whichwe are about to make application for Letters (I/we have made—or am/are about to make)	
	Patent of the United States of America;	
	AND WHEREAS, LINTEC CORPORATION of 23-23, Hon-cho, Itabashi-ku,	
	Tokyo 173-0001 JAPAN, is	
	desirous of acquiring an interest therein and in the Letters Patent to be obtained therefor from the	
	United States;	
	NOW THEREFORE, be it known by all whom it may concern, that for and in consideration of Ten Dollars (\$10.00)	
	Donats (φ========)	
	to in hand paid, the receipt of which is hereby acknowledged we	
l -	have assigned, sold, and set over, and by these presents do hereby assign, sell, and set over unto the said LINIEC CORPORATION	
	* the_entire right, title, and interest in and to the said invention,	
	as fully set forth and described in the:	
Delete inapplicab wording		
preparatory to obtaining Letters Patent therefor; said invention, application and Letters Paten		
	held and enjoyed by the saidLINTEC_CORPORATION	
	forits own use and behoof, and forits legal representatives, to the full end of the term	
for which said Letters Patent are granted, as fully and entirely as the same would have been		
	us had this assignment and sale not been made.	
	IN TESTIMONY WHEREOF, hereunto set _Qur _ hand _S_ and affix _our _ seal s_ at	
	this _3rd day of _July	
	Harry have bakate	
	(Inventor's full Signature)	
	akir Ichikana	
	Katsuhisa Tagualu	
	Yuichi Iwakata	

RECORDED: 08/21/2000

PATENT REEL: 011036 FRAME: 0159

^{*} State whether the full and exclusive right, or what part of the whole interest is assigned.